

## Description

The MDV3604URH uses advanced trench technology and design to provide excellent R<sub>DS(ON)</sub> with low gate charge .Thisdevice is well suited for high current load applications.

### **General Features**

 $V_{DS} = -30V, I_{D} = -32A$ 

 $R_{DS(ON)}$  <12m $\Omega$  @  $V_{GS}$ =-10V

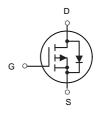
 $R_{DS(ON)}$  <18m $\Omega$  @  $V_{GS}$ =-4.5V

### **Application**

High side switch for full bridge converter DC/DC converter for LCD display



DFN3X3-8L



P-Channel MOSFET

## **Package Marking and Ordering Information**

Product ID	Pack	Brand	Qty(PCS)
MDV3604URH	DFN3X3-8L	HXY MOSFET	5000

# Absolute Maximum Ratings@Tj=25°C(unless otherwise specified)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	-30	V
VGS	Gate-Source Voltage	<u>+</u> 25	V
I <sub>D</sub> @T <sub>A</sub> =25°C	Drain Current <sup>3</sup> , V <sub>GS</sub> @ 10V	-32	А
I <sub>D</sub> @T <sub>A</sub> =70°C	Drain Current <sup>3</sup> , V <sub>GS</sub> @ 10V	-9.8	А
IDM	Pulsed Drain Current <sup>1</sup>	-65	А
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation	3.57	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Rthj-c	Maximum Thermal Resistance, Junction-case	6	°C/W
Rthj-a	Maximum Thermal Resistance, Junction- ambient <sup>3</sup>	35	°C/W



# Electrical Characteristics@ $T_j$ =25°C(unless otherwise specified)

Parameter	Test Conditions	Min.	Тур.	Max.	Units
Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA	-30	-	-	V
Static Drain-Source On-	V <sub>GS</sub> =-10V, I <sub>D</sub> =-15A	-	10	12	mΩ
Resistance <sup>2</sup>	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-10A	-	14	18	mΩ
Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250uA	-1	1.95	-2.5	V
Forward Transconductance	V <sub>DS</sub> =-10V, I <sub>D</sub> =-6A	-	19	-	S
Drain-Source Leakage Current	V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V	-	-	-30	uA
Gate-Source Leakage	V <sub>GS</sub> = <u>+</u> 20V, V <sub>DS</sub> =0V	-	-	<u>+</u> 100	nA
Total Gate Charge	I <sub>D</sub> =-15A	-	12.5	24	nC
Gate-Source Charge	V <sub>DS</sub> =-15V	-	5.4	-	nC
Gate-Drain ("Miller") Charge	V <sub>GS</sub> =-4.5V	-	5	-	nC
Turn-on Delay Time	V <sub>DS</sub> =-15V	-	4.4	-	ns
Rise Time	I <sub>D</sub> =-15A	-	11.2	-	ns
Turn-off Delay Time		-	34	-	ns
Fall Time	<b>T</b> V <sub>GS</sub> =-10V	-	18	-	ns
Input Capacitance	V <sub>GS</sub> =0V	-	1345	2000	pF
Output Capacitance	V <sub>DS</sub> =-15V	-	194	-	pF
Reverse Transfer Capacitance	-1-1.0IVII IZ.	-	158	-	pF
Reverse Recovery Time	I <sub>S</sub> =-15A, V <sub>GS</sub> =0V, dl/dt=100A/µs	-	12.4		ns
Reverse Recovery Charge		-	5	-	nC
	Drain-Source Breakdown Voltage Static Drain-Source On- Resistance <sup>2</sup> Gate Threshold Voltage Forward Transconductance Drain-Source Leakage Current Gate-Source Leakage Total Gate Charge Gate-Drain ("Miller") Charge Turn-on Delay Time Rise Time Turn-off Delay Time Fall Time Input Capacitance Output Capacitance Reverse Transfer Capacitance Reverse Recovery Time	Drain-Source Breakdown Voltage   V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA     Static Drain-Source On-Resistance <sup>2</sup>   V <sub>GS</sub> =-10V, I <sub>D</sub> =-15A     V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-10A     Gate Threshold Voltage   V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250uA     Forward Transconductance   V <sub>DS</sub> =-10V, I <sub>D</sub> =-6A     Drain-Source Leakage Current   V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V     Gate-Source Leakage   V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V     Total Gate Charge   I <sub>D</sub> =-15A     Gate-Drain ("Miller") Charge   V <sub>DS</sub> =-15V     Gate-Drain ("Miller") Charge   V <sub>DS</sub> =-15V     Rise Time   I <sub>D</sub> =-15A     Turn-off Delay Time   V <sub>GS</sub> =-10V     Fall Time   V <sub>GS</sub> =-10V     Input Capacitance   V <sub>GS</sub> =0V     Output Capacitance   V <sub>DS</sub> =-15V     F=1.0MHz     Reverse Transfer Capacitance   I <sub>S</sub> =-15A, V <sub>GS</sub> =0V, dI/dt=100A/µs	Drain-Source Breakdown Voltage   V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA   -30     Static Drain-Source On-Resistance <sup>2</sup>   V <sub>GS</sub> =-10V, I <sub>D</sub> =-15A   -	Drain-Source Breakdown Voltage   V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA   -30   -	Drain-Source Breakdown Voltage         V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA         -30         -         -           Static Drain-Source On-Resistance²         V <sub>GS</sub> =-10V, I <sub>D</sub> =-15A         -         10         12           V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-10A         -         14         18           Gate Threshold Voltage         V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250uA         -         1         1.95         -2.5           Forward Transconductance         V <sub>DS</sub> =-10V, I <sub>D</sub> =-6A         -         19         -           Drain-Source Leakage Current         V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V         -         -         -30           Gate-Source Leakage         V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V         -         -         -30           Gate-Source Leakage         I <sub>D</sub> =-15A         -         12.5         24           Gate-Source Charge         I <sub>D</sub> =-15A         -         12.5         24           Gate-Source Charge         V <sub>DS</sub> =-15V         -         5.4         -           Gate-Drain ("Miller") Charge         V <sub>DS</sub> =-15V         -         4.4         -           Rese Time         I <sub>D</sub> =-15A         -         11.2         -           Re-3.3Ω         -         -         4.4         -           Input Capacitance         V <sub>DS</sub> =-15V         -         <

#### Notes:

<sup>1.</sup> Pulse width limited by Max. junction temperature.

<sup>2.</sup>Pulse test



# **Typical Electrical**

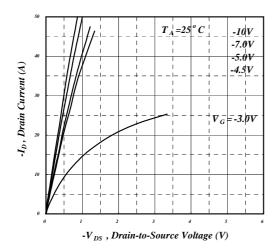


Fig 1. Typical Output Characteristics

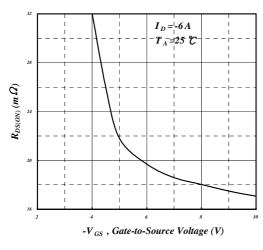


Fig 3. On-Resistance v.s. Gate Voltage

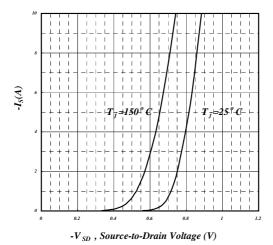


Fig 5. Forward Characteristic of Reverse Diode

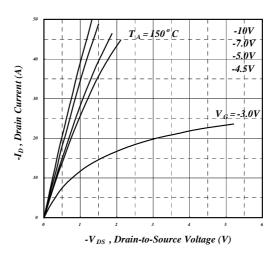


Fig 2. Typical Output Characteristics

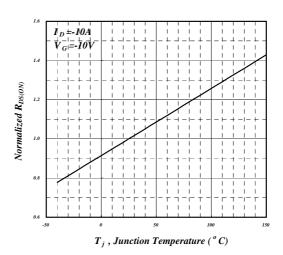


Fig 4. Normalized On-Resistance v.s. Junction Temperature

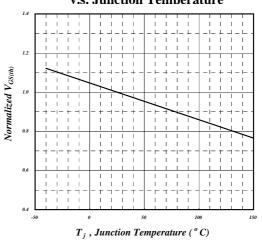


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

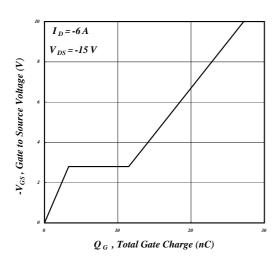


Fig 7. Gate Charge Characteristics

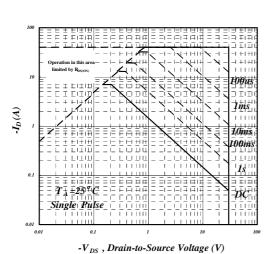


Fig 9. Maximum Safe Operating Area

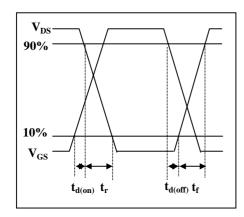


Fig 11. Switching Time Waveform

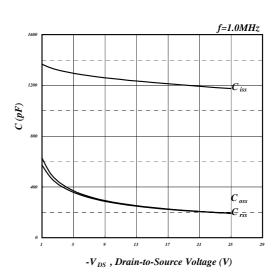


Fig 8. Typical Capacitance Characteristics

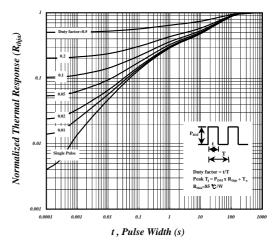


Fig 10. Effective Transient Thermal Impedance

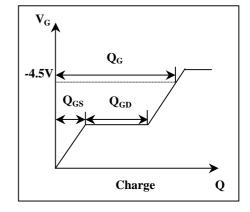
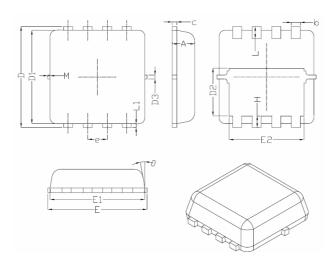


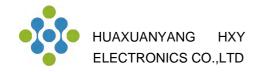
Fig 12. Gate Charge Waveform



# **DFN3X3-8L Package Information**



Complete I	Dimensions In Millimeters		
Symbol	Min.	Nom.	Max.
A	0.70	0.75	0.80
b	0.25	0.30	0.35
С	0.10	0.15	0.25
D	3.25	3.35	3.45
D1	3.00	3.10	3.20
D2	1.48	1.58	1.68
D3	-	0.13	-
Е	3.20	3.30	3.40
E1	3.00	3.15	3.20
E2	2.39	2.49	2.59
е	0.65BSC		
Н	0.30	0.39	0.50
L	0.30	0.40	0.50
L1	-	0.13	-
M	*	*	0.15
θ		10°	12 <sup>°</sup>



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